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| <b>INFORMATION DISCLOSURE<br/>STATEMENT BY APPLICANT</b><br>( Not for submission under 37 CFR 1.99) | Application Number     |                 | 10766799   |  |
|   | Filing Date            |                 | 2004-01-28 |  |
|   | First Named Inventor   | Kiyokazu Ohtaki |            |  |
|   | Art Unit               | 2632            |            |  |
|   | Examiner Name          | Hung S. Bui     |            |  |
|   | Attorney Docket Number | P27,548 USA     |            |  |

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| /HB/                     | 1       | 2001-200664                          | JP                          |                        | 2001-07-27       | Ohashi Yoshihiro                                | ENGLISH ABSTRACT   | <input type="checkbox"/> |
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| Examiner Signature | /Hung Bui/ | Date Considered | 04/26/2008 |
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